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The product specifications described in this book are subject to change without notice for the product which is currently under development. At the final stage of your design, purchasing, or use of the product, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.

User's Guide for Evaluation Board

Part No.	EVB-NN30310AA
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Industrial Devices Company
Panasonic Corporation

	2012-08-02	
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1 Introduction

This user's guide contains background information for the

NN30310AA : 3A Synchronous DCDC Step Down Regulator with Integrated Power MOSFET

as well as support documentation for the NN30310AA Evaluation Board (EVB-NN30310AA). Also included are the schematic, the test set-up, the bill of materials and the Board Layout for the Evaluation Board.

1.1 Overview

NN30310AA is a synchronous DCDC Step Down Regulator (1-ch) with integrated power MOSFETs, which employs hysteretic control system. By this system, when load current changes suddenly, it responds at high speed and minimizes the changes of output voltage.

Since it is possible to use capacitors with small capacitance and it is unnecessary to add external parts for system phase compensation, this IC realizes downsizing of set and reducing in the number of external parts.

Output voltage is adjustable by user. Maximum current is 3 A.

1.2 Features

- High-speed response DCDC Step Down Regulator circuit that employs the hysteretic control system
- Integrated Two 25m (Typ) MOSFETs for high efficiency
- Switchable FCCM (continuous) / SKIP (discontinuous) mode
- Input Voltage Range: 6.0V ~ 30V
- Output Voltage Range: 0.75V ~ 5.5V
- Built-in 0.6V ± 1% Reference Voltage
- Selectable Switching Frequency 250kHz / 750kHz / 1250kHz
- Adjustable Soft Start
- Low Operating and Standby Quiescent Current
- Indication for normal Output Voltage to PGOOD pin
- Built-in Under Voltage Lockout (UVLO), Thermal Shut Down (TSD), Output Over-Voltage Detection (OVD), Output Over-Current Protection (OCP), Short-Circuit Protection (SCP) functions

Input voltage and output current range for the evaluation Board are given in Table 1.

Table 1. Input Voltage and Output Current Summary

Evaluation Board	Input Voltage range	Output Current Range
EVB-NN30310AA	PVIN, AVIN = 6.0V to 30V *1 V-EN = 1.5V to 5V	0A to 3A

*1 : PVIN pin and AVIN pin are normally connected on Evaluation Board by 0 ohm resistor (R-AVIN).

1.3 Typical Applications

—High Current Distributed Power Systems such as HDDs (Hard Disk Drives), SSDs (Solid State Drives), PCs, Game consoles, Servers, Security Cameras, Network TVs, Home Appliances, OA Equipment etc.

1.4 Package

- 24pin Plastic Quad Flat Non-leaded Package Heat Slug Down (QFN Type)
(Size : 4 × 4 mm, 0.5 mm pitch)

1.5 Type

- Multichip IC

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1.6 Block Diagram

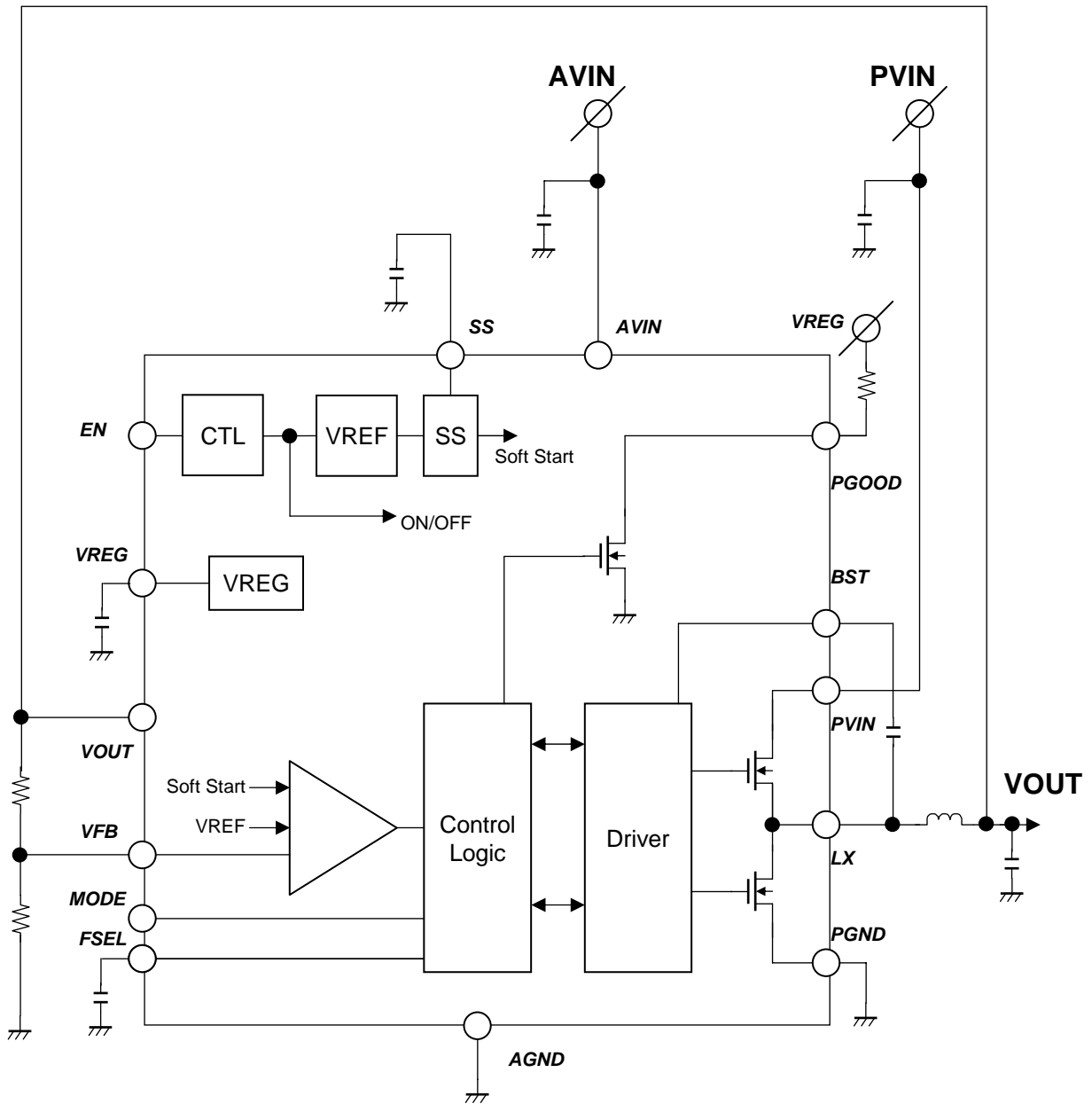


Figure 1. Block Diagram

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2 Evaluation Board

2.1 Appearance

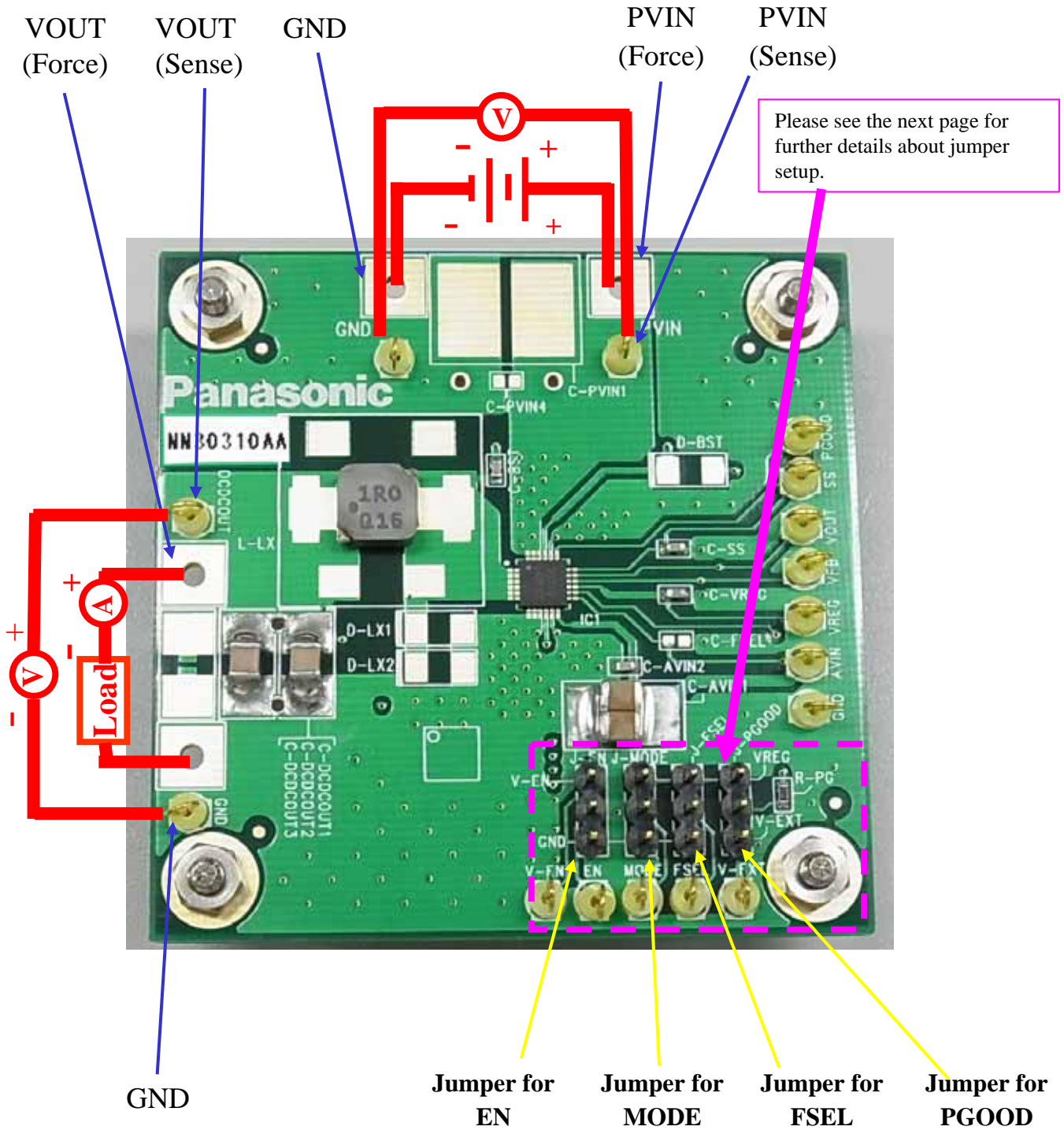


Figure 2. Appearance of Evaluation Board

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2.2 Jumper Setup

EN pin, MODE pin, FSEL pin, PGOOD pin are able to be controlled by J-EN, J-MODE, J-FSEL, J-PGOOD.

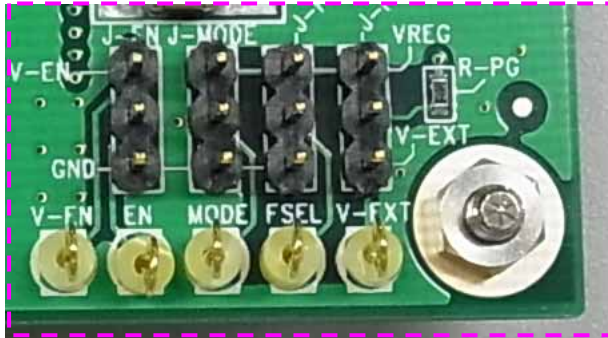


Figure 3. Appearance of J-EN, J-MODE, J-FSEL, J-PGOOD

Table 2. J-EN (Control enable/disable)




Jumper			
Status	enable	disable	disable

Table 3. J-MODE (Control modes)




Jumper			
Mode	FCCM	SKIP	SKIP

Table 4. J-FSEL (Control SW frequency)







Jumper			
Frequency	250kHz	750kHz	1250kHz

Table 5. J-PGOOD (Control the Voltage PGOOD pin pulled up to)

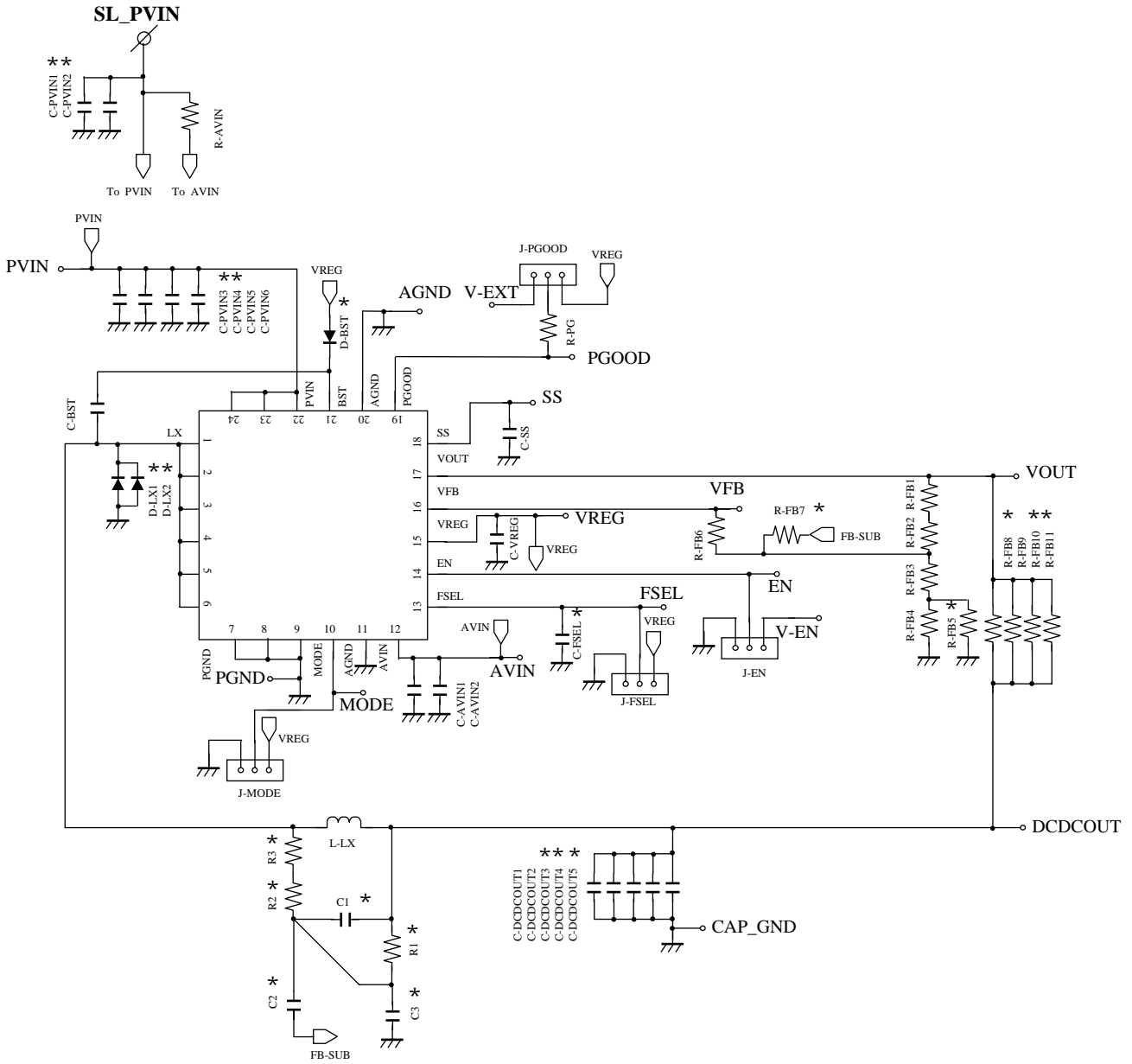
Jumper			
Pull up to	VREG	open	V-EXT

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3 Schematic



* : Not Installed

Figure 4. Evaluation Board Schematic

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4 Test Setup

This section describes how to properly connect, set up and use the Evaluation Board.

4.1 Main Test Points and Jumpers

The Evaluation Board is provided with test points and jumpers as shown in Table 6.

A power supply cable of supplying sufficient current must be connected to the pad PVIN. The load must be connected to the pad DCDCOUT. Wire lengths must be minimized to reduce losses in the wires.

Test point PVIN provides a place to monitor the input voltages with GND providing a convenient ground reference.













Test point DCDCOUT is used to monitor the output voltage with GND as the ground reference.

Jumper Setup is shown in Table 7.

Table 6. Function of Main Test points and Jumpers

	Reference Designator	Default	Function
Main Test Points	PVIN	-	PVIN test point at PVIN connector
	DCDCOUT	-	DCDCOUT test point at DCDCOUT connector
	V-EN	-	Test point supplying voltage to EN pin
Jumpers	J-EN	V-EN	3-pin headers for enable of NN30310AA. Connect EN to GND to disable, to V-EN to enable.
	J-MODE	VREG	3-pin headers to choose mode. Connect MODE to GND to choose SKIP mode, to VREG to choose FCCM mode.
	J-FSEL	-	3-pin headers to choose frequency. Connect FSEL to GND to choose 1250kHz, open to choose 750kHz, to VREG to choose 250kHz.
	J-PGOOD	open	3-pin headers for pull-up of PGOOD. Connect to VREG to allow pull up to VREG pin, to V-EXT to allow pull up to V-EXT pin.

Table 7. Jumper Setup

Jumper	Setup	Mode	Setup	Mode	Setup	Mode
J-EN	 V-EN EN pin GND	enable	 V-EN EN pin GND	disable	 V-EN EN pin GND	disable
J-MODE	 VREG MODE pin GND	FCCM mode	 VREG MODE pin GND	SKIP mode	 VREG MODE pin GND	SKIP mode
J-FSEL	 VREG FSEL pin GND	250kHz	 VREG FSEL pin GND	750kHz	 VREG FSEL pin GND	1250kHz
J-PGOOD	 Pull up to VREG PGOOD pin Pull up to V-EXT	Pull up to VREG	 Pull up to VREG PGOOD pin Pull up to V-EXT	open	 Pull up to VREG PGOOD pin Pull up to V-EXT	Pull up to V-EXT

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4.2 Output Voltage Setpoint

To change the output voltage of the Evaluation Board, it is necessary to change the value of resistor R-FB1~R-FB4. The values of R-FB1~R-FB4 for a specific output value can be calculated using Equation (1).

For output voltage from 0.75V to 5.5V:

$$V_{out} = \left(\frac{R-FB1 + R-FB2 + R-FB3 + R-FB4}{R-FB3 + R-FB4} \right) \times 0.6 \quad \text{----- (1)}$$

Table 8 lists the R-FB1~R-FB4 values for some common output voltage.

Table 8. Output Voltages

Output Voltage (V)	R-FB1(k ohm)	R-FB2(k ohm)	R-FB3(k ohm)	R-FB4(k ohm)
1.00	1.0	0	1.5	0
1.05	1.2	0	1.6	0
1.20	1.5	0	1.5	0
1.80	1.0	1.0	1.0	0
2.50	4.7	1.0	1.8	0
3.30	3.3	1.2	1.0	0
5.00	10.0	1.0	1.5	0

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5 Bill of Materials

Table 9 presents the bill of materials for the Evaluation Board.

Table 9. Evaluation Board Bill of Materials

Reference Designator	QTY	Value	Description	Size *4	Manufacturer	Part Number
C1, C2,C3	-	-	-	-	-	-
C-AVIN1	2	10uF	Capacitor, Ceramic, 50V, X7R, 20%	1210	TAIYO YUDEN	UMK325AB7106MM-T
C-AVIN2	1	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	0603	Murata	GRM188R72A104KA35L
C-BST	1	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	0603	Murata	GRM188R72A104KA35L
C-DCDCOUT	2	22uF	Capacitor, Ceramic, 25V, X7R, 10%	1210	Murata	GRM32ER71E226KE15L
C-FSEL	-	-	-	-	-	-
C-PVIN1, C-PVIN2, C-PVIN3, C-PVIN4	-	-	-	-	-	-
C-PVIN5	2	10uF	Capacitor, Ceramic, 50V, X7R, 20%	1210	TAIYO YUDEN	UMK325AB7106MM-T
C-PVIN6	1	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	0603	Murata	GRM188R72A104KA35L
C-SS	1	10nF	Capacitor, Ceramic, 100V, X7R, 10%	0603	Murata	GRM188R72A103KA01L
C-VREG	1	1.0uF	Capacitor, Ceramic, 25V, X7R, 10%	0603	Murata	GRM188R71E105KA12L
D-BST	-	-	-	-	-	-
D-LX1, D-LX2	-	-	-	-	-	-
J-EN, J-FSEL, J-MODE, J-PGOOD	-	-	-	-	-	-
L-LX	1	1.0uH	Inductor, 8.1A, 6.9m	0.276 × 0.260 inch	Panasonic	ETQP3W1R0WFN
R1,R2,R3	-	-	-	-	-	-
R-AVIN	1	0	Resistor, Chip, 0.1W	0603	Panasonic	ERJ3GEY0R00V
R-FB1 *2	1	3.3k	Resistor, Chip, 0.1W, 1%	0603	Panasonic	ERJ3EKF3301V
R-FB2 *2	1	1.2k	Resistor, Chip, 0.1W, 1%	0603	Panasonic	ERJ3EKF1201V
R-RB3 *2	1	1.0k	Resistor, Chip, 0.1W, 1%	0603	Panasonic	ERJ3EKF1001V
R-FB4 *2	1	0	Resistor, Chip, 0.1W	0603	Panasonic	ERJ3GEY0R00V
R-FB6	1	0	Resistor, Chip, 0.1W	0603	Panasonic	ERJ3GEY0R00V
R-FB5, R-FB7	-	-	-	-	-	-
R-FB9 *3	1	0	Resistor, Chip, 0.1W	0603	Panasonic	ERJ3GEY0R00V
R-FB8, R-FB10, R-FB11 *3	-	-	-	-	-	-
R-PG	1	100k	Resistor, Chip, 0.1W, 1%	0603	Panasonic	ERJ3EKF1003V

*2 : These resistors determine output voltage.

The setting in the above table sets the output voltage for 3.3V.

To change the output voltage, it is necessary to change these resistors following Equation (1) in the section 4.2.

*3 : These pads are for changing feedback route.

Only R-FB9 is normally installed.

*4 : These values comply with EIA standards.

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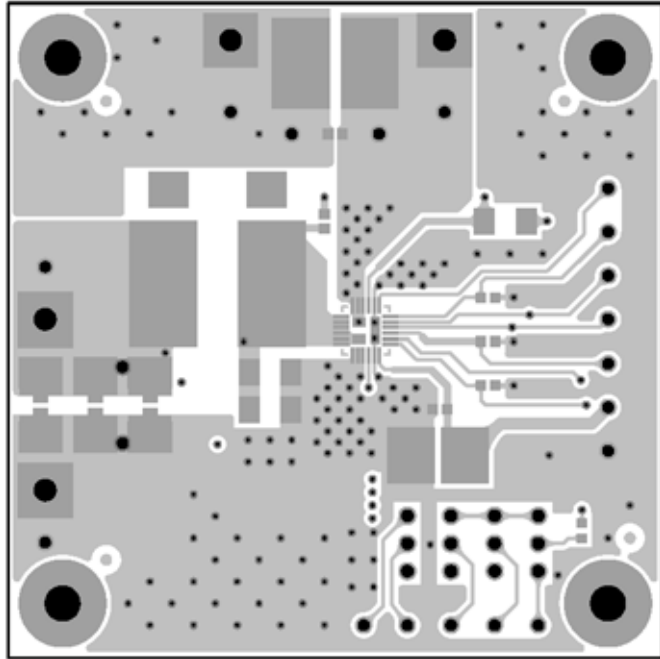


Figure 7. Top Layer (Top View)

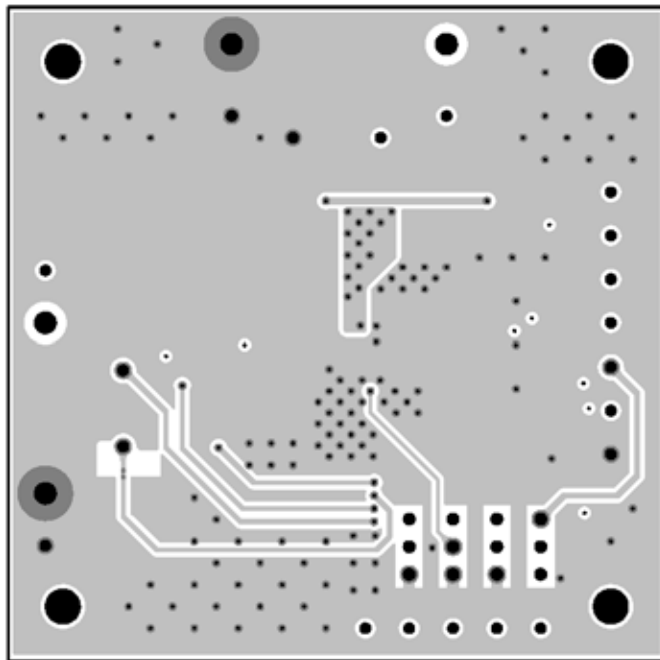


Figure 8. Layer 2 (Top View)

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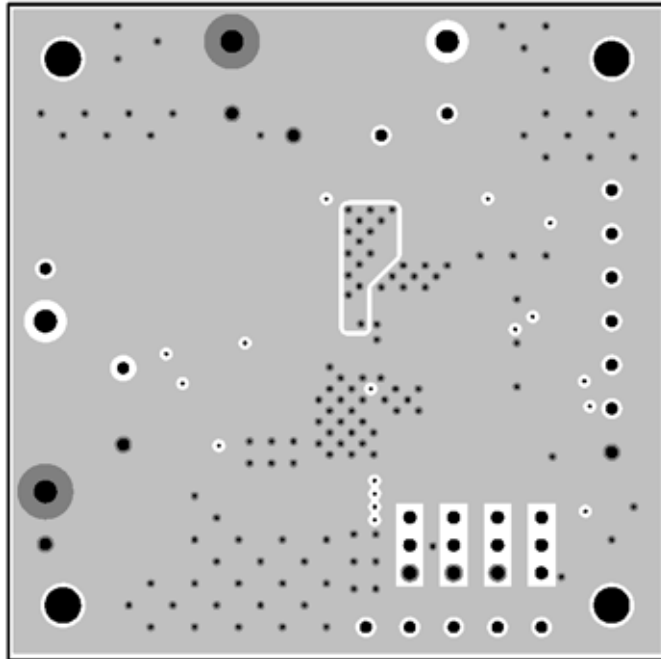


Figure 9. Layer 3 (Top View)

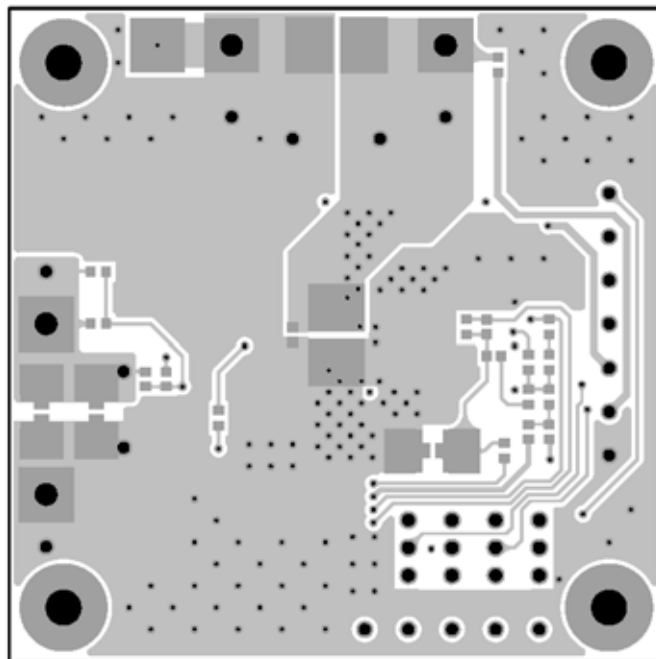


Figure 10. Bottom Layer (Top View)

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■ Usage Notes

— Special attention and precaution in using

1. This DCDC Step Down Regulator is intended to be used for general electronic equipment.
Consult our sales staff in advance for information on the following applications:
 - Special applications in which exceptional quality and reliability are required, or if the failure or malfunction of this IC may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
 - (1) Space appliance (such as artificial satellite, and rocket)
 - (2) Traffic control equipment (such as for automobile, airplane, train, and ship)
 - (3) Medical equipment for life support
 - (4) Submarine transponder
 - (5) Control equipment for power plant
 - (6) Disaster prevention and security device
 - (7) Weapon
 - (8) Others : Applications of which reliability equivalent to (1) to (7) is required

It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the IC described in this book for any special application, unless our company agrees to your using the IC in this book for any special application.

2. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
3. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
4. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
5. Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-V_{CC} short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short) .
And, safety measures such as an installation of fuses are recommended because the extent of the above-mentioned damage and smoke emission will depend on the current capability of the power supply.
6. When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
7. When using the LSI for new models, verify the safety including the long-term reliability for each product.
8. When the application system is designed by using this LSI, be sure to confirm notes in this book.
Be sure to read the notes to descriptions and the usage notes in the book.
9. Connect the metallic plates on the back side of the IC with respective potentials (AGND, PVIN, LX). The thermal resistance and the electrical characteristics are guaranteed only when the metallic plates are connected with respected potentials.

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Request for your special attention and precautions in using the technical information and semiconductors described in this book

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- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for general applications (such as office equipment, communications equipment, measuring instruments and household appliances), or for specific applications as expressly stated in this book. Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automotive equipment, traffic signaling equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the products described in this book for any special application, unless our company agrees to your using the products in this book for any special application.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
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